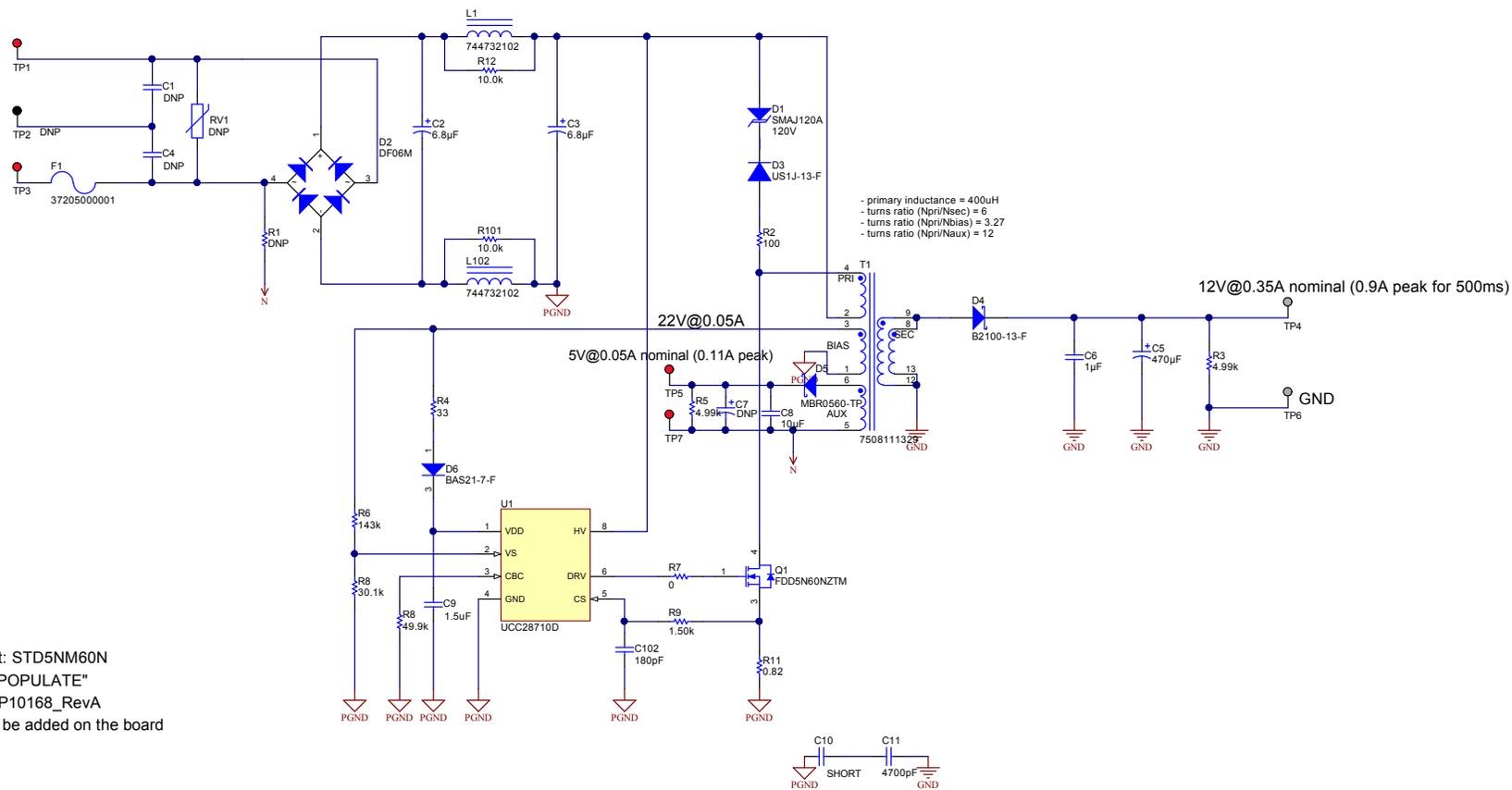


85VAC - 265VAC



**Notes:**

- Q1 alternative part: STD5NM60N
- DNP = "DO NOT POPULATE"
- built on Board PMP10168\_RevA
- refDES>100 must be added on the board

Orderable: N/A	Designed for:	Mod. Date: 8/12/2015
TID #:	Project Title: PSR Quasi-Resonant Flyback Converter	
Number: PMP10168   Rev: A	Sheet Title:	Sheet 2 of 3
Drawn By: [Redacted]	Assembly Variant: [No Variations]	File: PMP10168_RevA_SchDoc
Engineer: F. Mueller	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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